



**FCT Assembly**  
LEADERS IN TECHNOLOGY

# Technical Bulletin

## WS89 REPAIR FLUX GEL

### DESCRIPTION:

WS89 REPAIR FLUX GEL is a water soluble tacky dispensing flux ideally suited for BGA and surface mount component repairs. It leaves a residue which cleans easily in water. WS89 Flux Gel is excellent for both leaded and lead-free applications.

- COMPLETELY WATER SOLUBLE
- SUITABLE FOR BGA REPAIR
- SUITABLE FOR DISPENSING, STENCIL PRINTING, AND PIN TRANSFER
- EXCELLENT SMT REWORK FLUX

### PHYSICAL PROPERTIES

Solids Content  
Acid Number (mgKOH/gm)  
Color  
Halide content  
J-STD-004 Classification

### VALUES

58 to 62% wt  
65 – 70  
BROWN  
0.4 – 0.5% wt  
ORH1

### SAFETY AND HANDLING

Use in well-ventilated area and observe standard precautions for handling and use. Refer to the Material Safety Data Sheet for further information.

**Available in 50 gram jar, 10cc and 30cc cartridges.  
Refer to MSDS for additional information.**

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